

## 60V N-Channel Enhancement Mode Power MOSFET

### Description

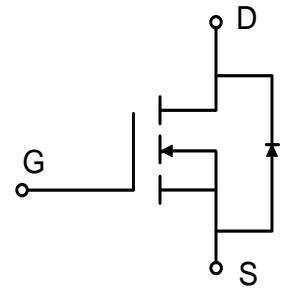
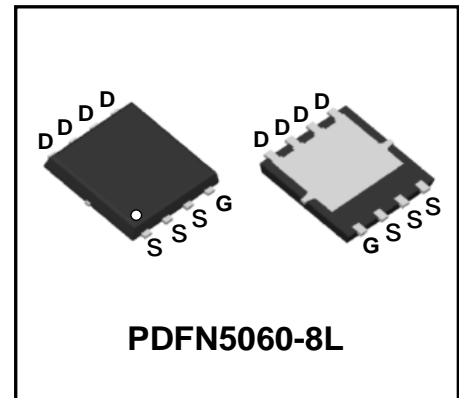
WMB85N06T2 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

### Features

- $V_{DS} = 60V$ ,  $I_D = 85A$   
 $R_{DS(on)} < 3.6m\Omega @ V_{GS} = 10V$   
 $R_{DS(on)} < 5.4m\Omega @ V_{GS} = 4.5V$
- Low  $R_{DS(on)}$
- Low Gate Charge
- 100% EAS Guaranteed

### Applications

- Power Management Switches
- Synchronous Rectification for AC/DC Quick Charger



### Absolute Maximum Ratings

| Parameter  |                     | Symbol         | Value       | Unit       |
|--|---------------------|----------------|-------------|------------|
| Drain-Source voltage                             |                     | $V_{DS}$       | 60          | V          |
| Gate-Source voltage                              |                     | $V_{GS}$       | $\pm 20$    | V          |
| Continuous Drain Current <sup>1,6</sup>          | $T_C = 25^\circ C$  | $I_D$          | 85          | A          |
|  | $T_C = 100^\circ C$ |                | 66          |            |
| Pulsed Drain Current <sup>2</sup>                |                     | $I_{DM}$       | 240         | A          |
| Single Pulse Avalanche Energy <sup>3</sup>       |                     | <b>EAS</b>     | 101         | mJ         |
| Avalanche Current                                |                     | $I_{AS}$       | 45          | A          |
| Total Power Dissipation <sup>4</sup>             | $T_C = 25^\circ C$  | $P_D$          | 83          | W          |
| Operating Junction and Storage Temperature Range |                     | $T_J, T_{STG}$ | -55 to +150 | $^\circ C$ |

### Thermal Characteristics

| Parameter  | Symbol          | Value | Unit         |
|--|-----------------|-------|--------------|
| Thermal Resistance from Junction-to-Ambient <sup>1</sup> | $R_{\theta JA}$ | 55    | $^\circ C/W$ |
| Thermal Resistance from Junction-to-Case <sup>1</sup>    | $R_{\theta JC}$ | 1.5   | $^\circ C/W$ |

**Electrical Characteristics**  $T_c = 25^\circ\text{C}$ , unless otherwise noted

| Parameter                                      | Symbol                 | Test Conditions  | Min.                        | Typ. | Max.      | Unit       |         |
|--|------------------------|--|-----------------------------|------|-----------|------------|---------|
| <b>Static Characteristics</b>                  |                        |  |                             |      |           |            |         |
| Drain-Source Breakdown Voltage                 | $V_{(BR)DSS}$          | $V_{GS} = 0V, I_D = 250\mu A$                              | 60                          | -    | -         | V          |         |
| Gate-body Leakage current                      | $I_{GSS}$              | $V_{DS} = 0V, V_{GS} = \pm 20V$                            | -                           | -    | $\pm 100$ | nA         |         |
| Zero Gate Voltage Drain Current                | $T_J=25^\circ\text{C}$ | $I_{DSS}$  | $V_{DS} = 48V, V_{GS} = 0V$ | -    | -         | 1          | $\mu A$ |
|  | $T_J=55^\circ\text{C}$ |  |                             | -    | -         | 5          |         |
| Gate-Threshold Voltage                         | $V_{GS(th)}$           | $V_{DS} = V_{GS}, I_D = 250\mu A$                          | 1.2                         | 1.7  | 2.3       | V          |         |
| Drain-Source On-Resistance <sup>2</sup>        | $R_{DS(on)}$           | $V_{GS} = 10V, I_D = 20A$                                  | -                           | 2.5  | 3.6       | m $\Omega$ |         |
|  |                        | $V_{GS} = 4.5V, I_D = 15A$                                 | -                           | 3.8  | 5.4       |            |         |
| Forward Trans conductance                      | $g_{fs}$               | $V_{DS} = 5V, I_D = 20A$                                   | -                           | 65   | -         | S          |         |
| <b>Dynamic Characteristics</b>                 |                        |  |                             |      |           |            |         |
| Input Capacitance                              | $C_{iss}$              | $V_{DS} = 30V, V_{GS} = 0V, f = 1MHz$                      | -                           | 3458 | -         | $\mu F$    |         |
| Output Capacitance                             | $C_{oss}$              |  | -                           | 1226 | -         |            |         |
| Reverse Transfer Capacitance                   | $C_{rss}$              |  | -                           | 78   | -         |            |         |
| <b>Switching Characteristics</b>               |                        |  |                             |      |           |            |         |
| Gate Resistance                                | $R_g$                  | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$                       | -                           | 0.7  | -         | $\Omega$   |         |
| Total Gate Charge                              | $Q_g$                  | $V_{GS} = 10V, V_{DS} = 30V, I_D = 20A$                    | -                           | 58   | -         | nC         |         |
| Gate-Source Charge                             | $Q_{gs}$               |  | -                           | 16   | -         |            |         |
| Gate-Drain Charge                              | $Q_{gd}$               |  | -                           | 4    | -         |            |         |
| Turn-On Delay Time                             | $t_{d(on)}$            | $V_{GS} = 10V, V_{DD} = 30V$<br>$R_G = 3\Omega, I_D = 20A$ | -                           | 18   | -         | nS         |         |
| Rise Time                                      | $t_r$                  |  | -                           | 8    | -         |            |         |
| Turn-Off Delay Time                            | $t_{d(off)}$           |  | -                           | 50   | -         |            |         |
| Fall Time                                      | $t_f$                  |  | -                           | 10.5 | -         |            |         |
| <b>Drain-source body diode Characteristics</b> |                        |  |                             |      |           |            |         |
| Diode Forward Voltage <sup>2</sup>             | $V_{SD}$               | $I_S = 1A, V_{GS} = 0V$                                    | -                           | -    | 1.2       | V          |         |
| Continuous Source Current <sup>1,5</sup>       | $I_S$                  | $V_G = V_D = 0V$ , Force Current                           | -                           | -    | 55        | A          |         |
| Body Diode Reverse Recovery Time               | $t_{rr}$               | $I_F = 20A, dI/dt = 100A/\mu s$                            | -                           | 24   | -         | nS         |         |
| Body Diode Reverse Recovery Charge             | $Q_{rr}$               |  | -                           | 85   | -         | nC         |         |

## Notes:

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is  $V_{DD}=50V, V_{GS}=10V, L=0.1mH, I_{AS}=45A$
4. The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

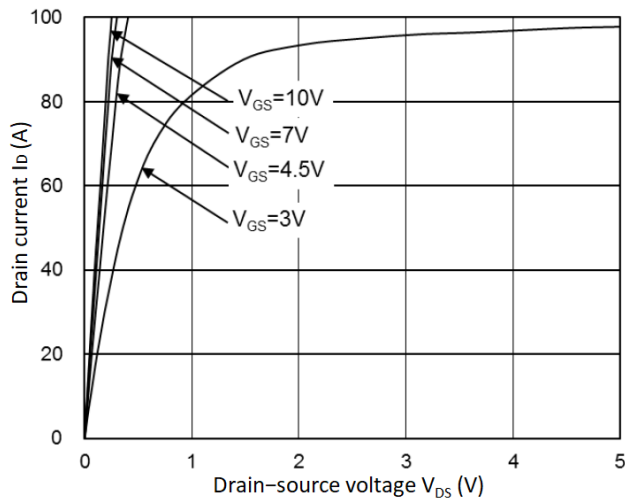


Figure 1. Typical Output Characteristics

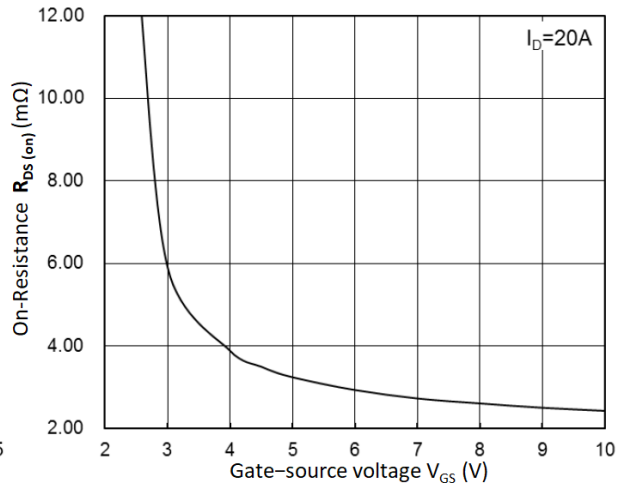


Figure 2.  $R_{DS(on)}$  vs.  $V_{GS}$

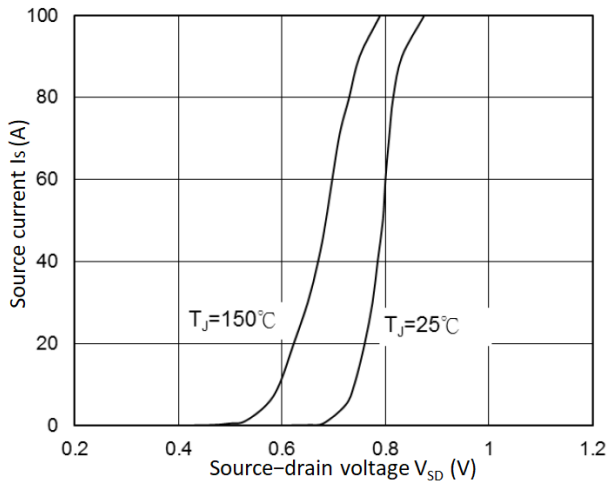


Figure 3. Forward Characteristics Of Reverse

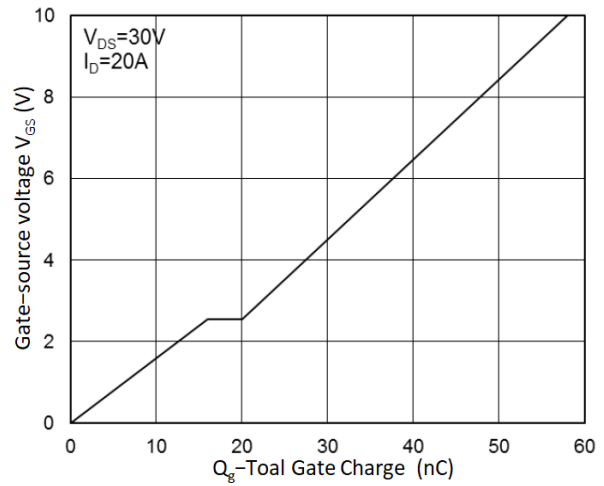


Figure 4. Gate Charge Characteristics

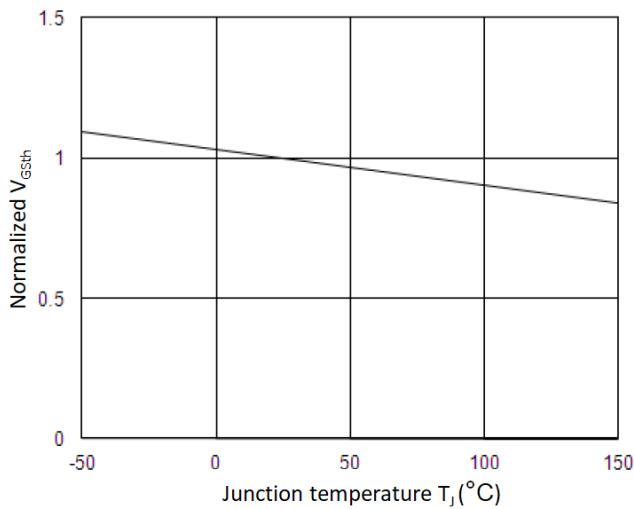


Figure 5. Normalized  $V_{GS(th)}$  vs.  $T_J$

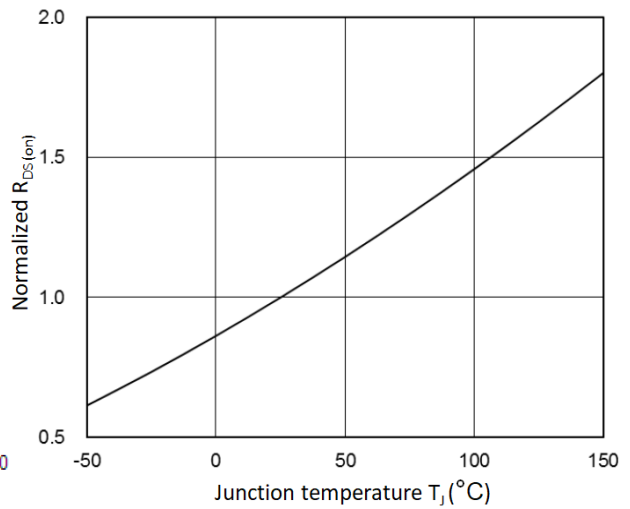


Figure 6. Normalized  $R_{DS(on)}$  vs.  $T_J$

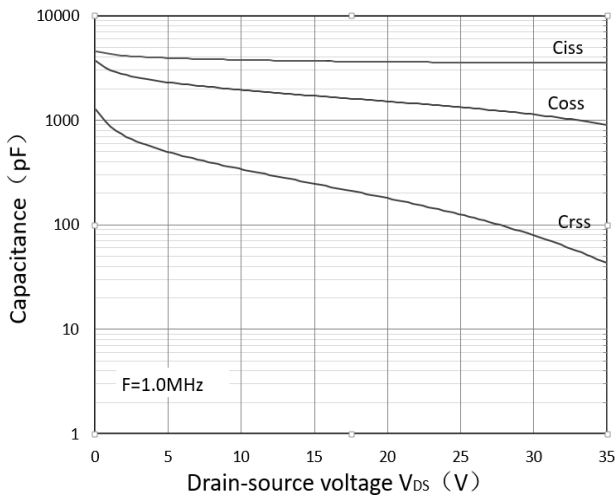


Figure 7. Capacitance Characteristics

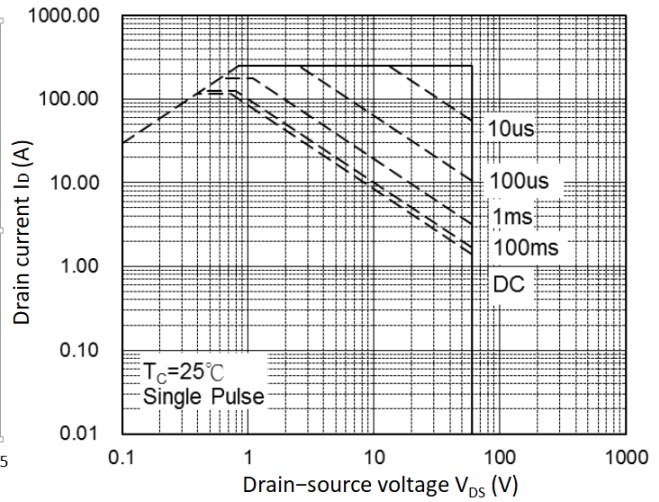


Figure 8. Safe Operating Area

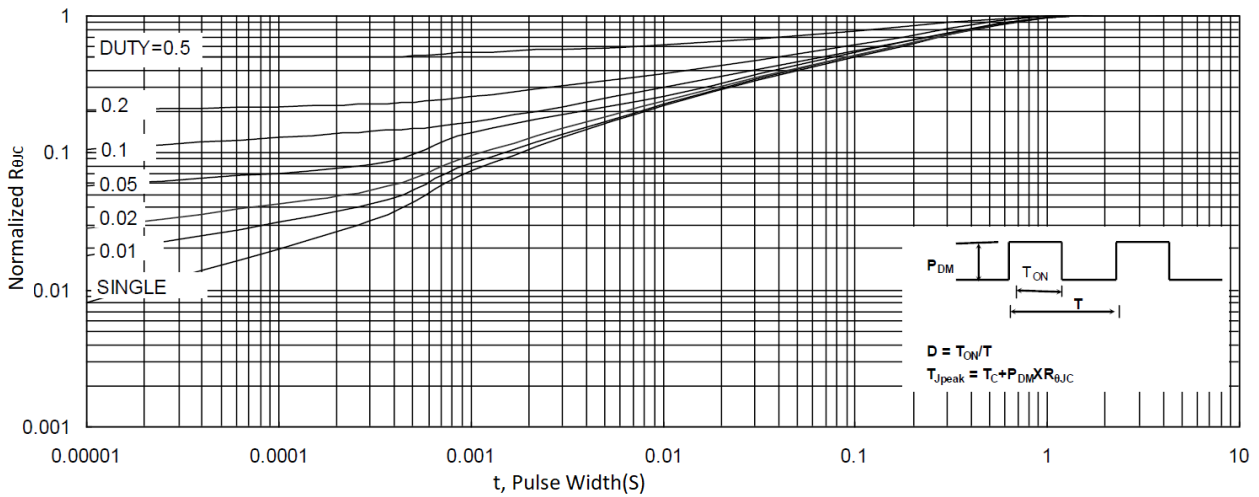


Figure 9. Normalized Maximum Transient Thermal Impedance

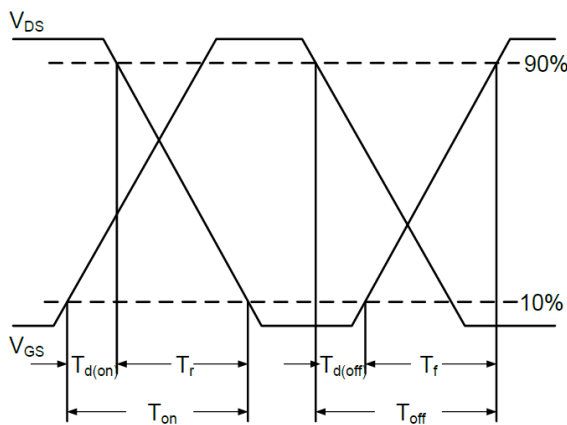


Figure 10. Switching Time Waveform

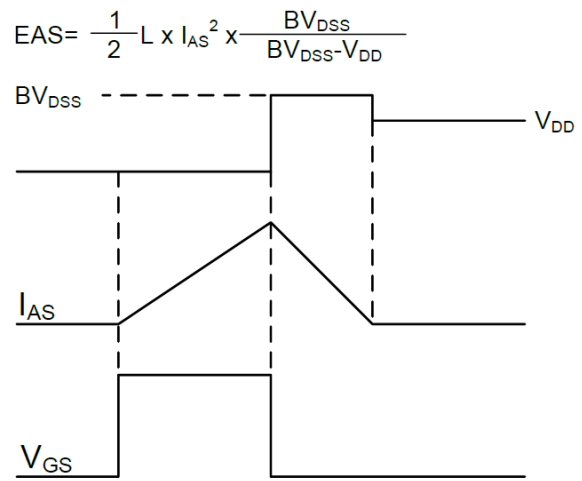
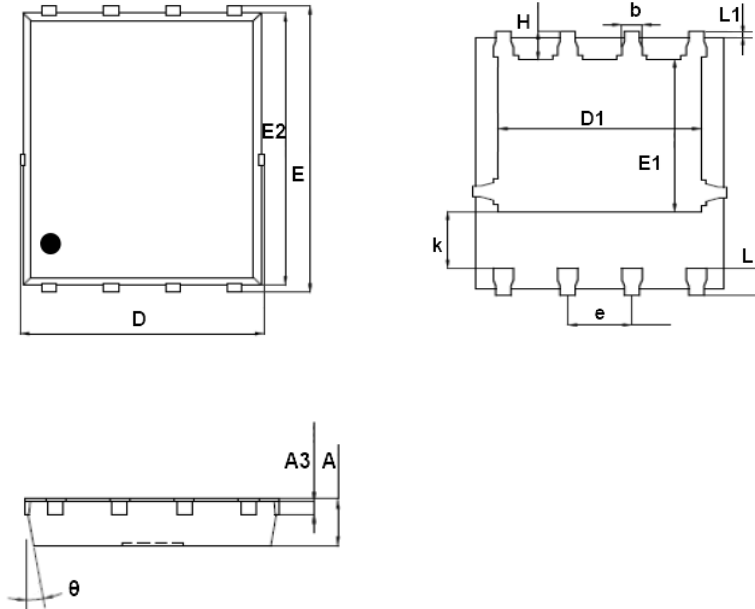


Figure 11. Unclamped Inductive Switching Waveform

$$EAS = \frac{1}{2} L \times I_{AS}^2 \times \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$

## Mechanical Dimensions for PDFN5060-8L

## COMMON DIMENSIONS

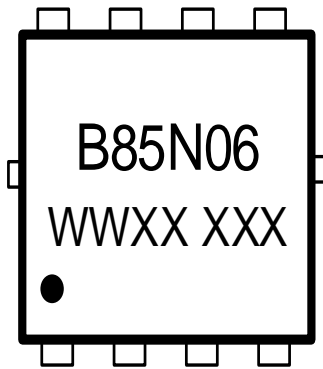


| SYMBOL   | MM      |      |
|----------|---------|------|
|          | MIN     | MAX  |
| A        | 0.90    | 1.20 |
| A3       | 0.15    | 0.35 |
| D        | 4.80    | 5.40 |
| E        | 5.90    | 6.35 |
| D1       | 3.61    | 4.31 |
| E1       | 3.3     | 3.92 |
| E2       | 5.65    | 6.06 |
| k        | 1.10    | -    |
| b        | 0.30    | 0.51 |
| e        | 1.27BSC |      |
| L        | 0.38    | 0.71 |
| L1       | 0.05    | 0.36 |
| H        | 0.38    | 0.61 |
| $\theta$ | 0°      | 12°  |

## Ordering Information

| Part       | Package     | Marking | Packing method |
|------------|-------------|---------|----------------|
| WMB85N06T2 | PDFN5060-8L | B85N06  | Tape and Reel  |

## Marking Information



B85N06 = Device code

WWXX XXX= Date code


## Contact Information

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